

INN100FQ016A

100V Enhancement-mode GaN Power Transistor

INN100FQ016A

1. General description

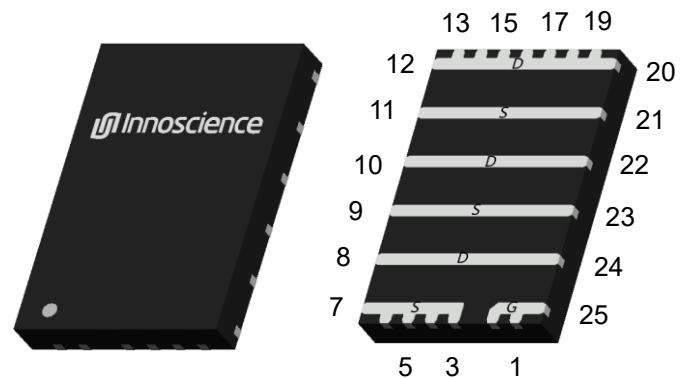
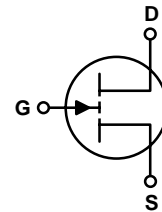
GaN-on-Silicon enhancement mode high-electron-mobility-transistor (HEMT) in FCQFN with 4.0 mm x 6.0 mm package size.

2. Features

- GaN-on-Silicon E-mode HEMT technology
- Very low gate charge
- Ultra-low on resistance
- Very small footprint

3. Applications

- High frequency DC-DC converter
- Point of Load
- RF envelope tracking
- PC charger
- Mobile power bank
- Motor driver



4. Key performance parameters

Table 1 Key performance parameters at $T_J = 25\text{ }^\circ\text{C}$

Parameter	Value	Unit
$V_{DS,max}$	100	V
$R_{DS(on),max}$ @ $V_{GS} = 5\text{ V}$	1.8	m Ω
$Q_{G,typ}$ @ $V_{DS} = 50\text{ V}$	22	nC
$I_{DS,Pulse}$	320	A
Q_{OSS} @ $V_{DS} = 50\text{ V}$	125	nC

5. Pin information

Table 2 Pin information

Pin	Pin description	Pin function
1,2,25	Gate	Driver Gate
3-7,9,11,21,23	Source	Source
8,10,12-20,22,24	Drain	Power Drain

Table 3 Ordering information

Type/Ordering Code	Package	Product Code
INN100FQ016A	FCQFN 4X6	J23

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6. Maximum ratings

at $T_J = 25\text{ }^\circ\text{C}$ unless otherwise specified.

Continuous application of maximum ratings can deteriorate transistor lifetime. For further information, contact Innoscence sales office.

Table 4 Maximum ratings

SYMBOL	PARAMETER	MAX	UNIT
V_{DS}	Drain-to-Source Voltage (Continuous)	100	V
I_D	Continuous current	100	A
	Pulsed ($25\text{ }^\circ\text{C}$, $T_{Pulse} = 100\text{ }\mu\text{s}$)	320	A
V_{GS}	Gate-to-Source Voltage	6	V
	Gate-to-Source Voltage	-4	V
T_J	Operating Temperature	-40 to 150	$^\circ\text{C}$
T_{STG}	Storage Temperature	-40 to 150	$^\circ\text{C}$

7. Thermal characteristics

Table 5 Thermal characteristics

SYMBOL	PARAMETER	TYP	UNIT
$R_{\theta JC}$	Thermal Resistance, Junction to Case	8.78	$^{\circ}\text{C}/\text{W}$
$R_{\theta JB}$	Thermal Resistance, Junction to Board	1.32	$^{\circ}\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient ¹	59.05	$^{\circ}\text{C}/\text{W}$

Note 1: $R_{\theta JA}$ is determined with the device mounted on one square inch of copper pad, single layer 2 oz copper on FR4 board.

8. Electric characteristics

at $T_J = 25\text{ }^\circ\text{C}$, unless specified otherwise

Table 6 Static characteristics

SYMBOL	PARAMETER	MIN	TYP	MAX	UNIT	TEST CONDITIONS
BV_{DSS}	Drain-to-Source Voltage	100	-	-	V	$V_{GS} = 0\text{ V}$, $I_D = 900\text{ }\mu\text{A}$
I_{DSS}	Drain Source Leakage	-	9.5	93	μA	$V_{GS} = 0\text{ V}$, $V_{DS} = 80\text{ V}$
I_{GSS}	Gate-to-Source Forward Leakage	-	2.8	55	μA	$V_{GS} = 5\text{ V}$
	Gate-to-Source Reverse Leakage	-	0.3	1.2	μA	$V_{GS} = -4\text{ V}$
$V_{GS(TH)}$	Gate Threshold Voltage	0.8	1.1	2.5	V	$V_{DS} = V_{GS}$, $I_D = 21\text{ mA}$
$R_{DS(on)}$	Drain-Source On-state Resistance	-	1.4	1.8	$\text{m}\Omega$	$V_{GS} = 5\text{ V}$, $I_D = 40\text{ A}$
V_{SD}	Source-Drain Forward Voltage	-	1.5	-	V	$I_S = 0.5\text{ A}$, $V_{GS} = 0\text{ V}$

Table 7 Dynamic characteristics

SYMBOL	PARAMETER	MIN	TYP	MAX	UNIT	TEST CONDITIONS
C _{ISS}	Input Capacitance	-	2500	-	pF	V _{GS} = 0 V, V _{DS} = 50 V
C _{OSS}	Output Capacitance	-	1100	-		V _{GS} = 0 V, V _{DS} = 50 V
C _{RSS}	Reverse Transfer Capacitance	-	19	-		V _{GS} = 0 V, V _{DS} = 50 V
C _{OSS(ER)}	Energy Related C _{OSS}	-	1700	-		V _{GS} = 0 V, V _{DS} = 0 V to 50 V
C _{OSS(TR)}	Time Related C _{OSS}	-	2500	-		V _{GS} = 0 V, V _{DS} = 0 V to 50 V
R _G	Gate resistance	-	1.8	-	Ω	f = 5 MHz, open drain
Q _G	Total Gate Charge	-	22	-	nC	V _{GS} = 5 V, V _{DS} = 50 V, I _D =40 A
Q _{GS}	Gate to Source Charge	-	4.5	-		V _{DS} = 50 V, I _D =40 A
Q _{GD}	Gate to Drain Charge	-	4.5	-		V _{DS} = 50 V, I _D =40 A
Q _{G(TH)}	Gate Charge at Threshold	-	2.5	-		V _{DS} = 50 V, I _D =40 A
Q _{OSS}	Output Charge	-	125	-		V _{GS} = 0 V, V _{DS} = 50 V

9. Electric characteristics diagrams

at $T_J = 25\text{ }^\circ\text{C}$, unless specified otherwise

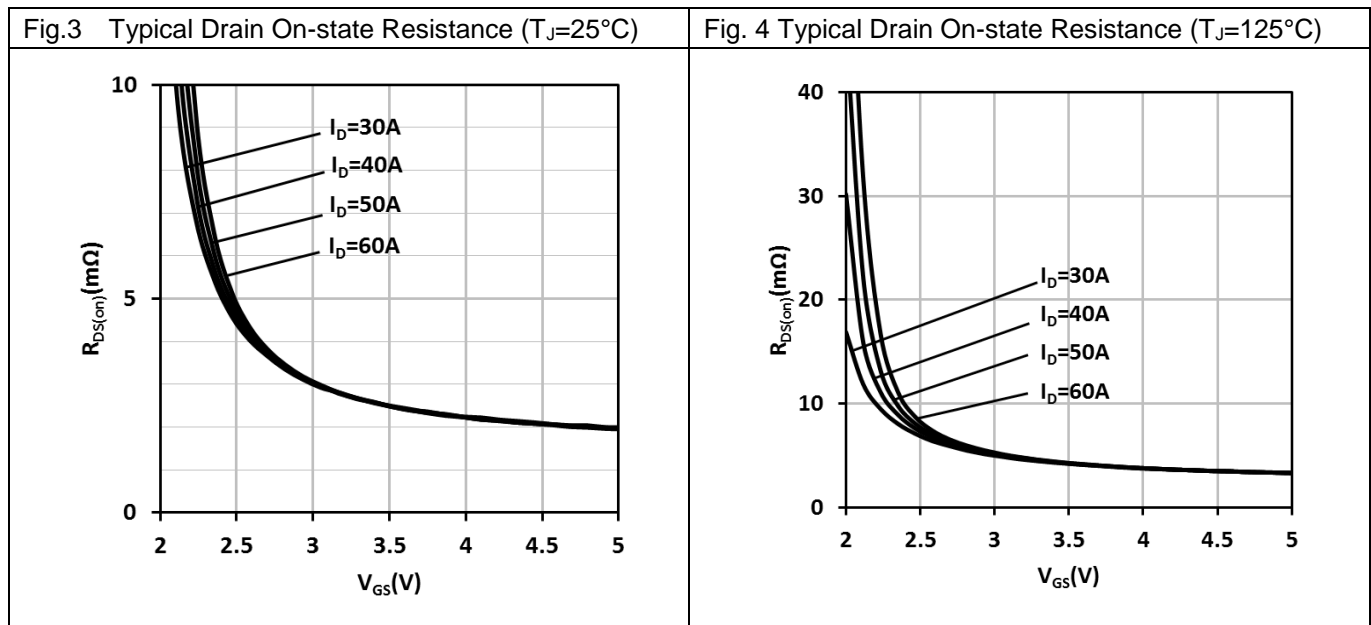
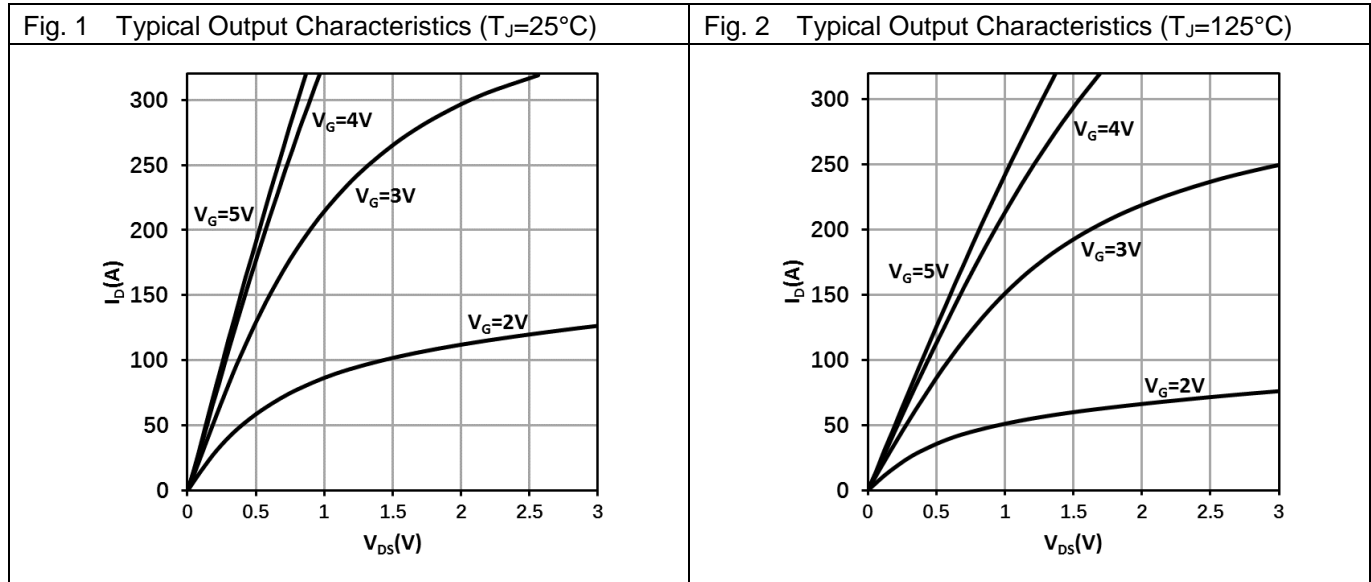


Fig. 5 Normalized On-State Resistance vs. Temp.

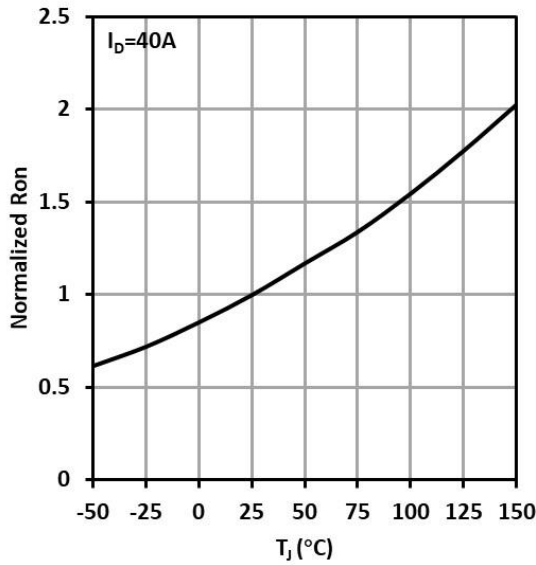


Fig. 6 Typical Transfer Characteristics

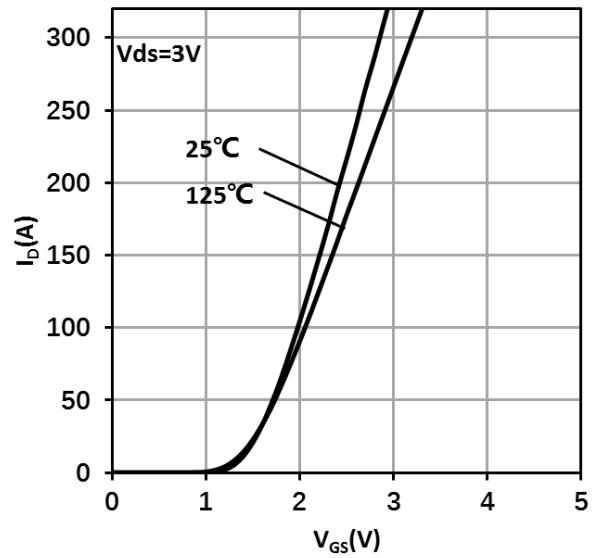


Fig. 7 Typ. Reverse Drain-Source Characteristics ($V_{GS} \leq 0, T_J = 25^\circ\text{C}$)

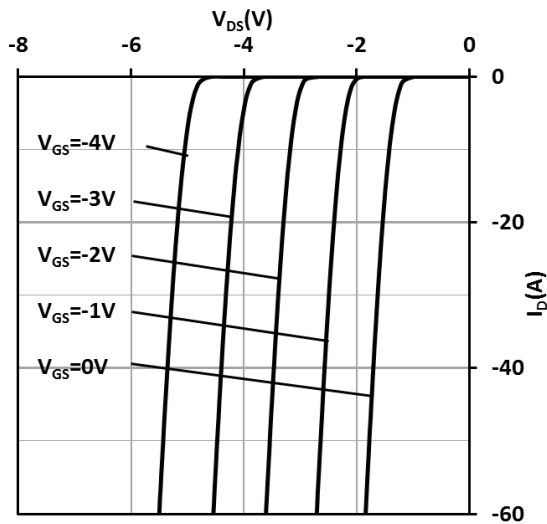


Fig. 8 Typ. Reverse Drain-Source Characteristics ($V_{GS} \geq 0, T_J = 25^\circ\text{C}$)

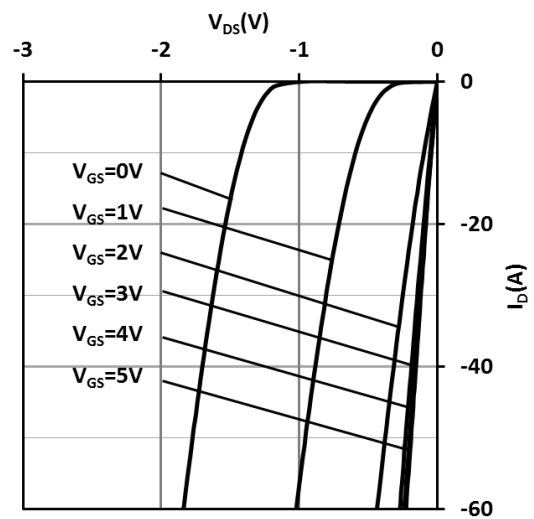


Fig. 9 Typ. Reverse Drain-Source Characteristics ($V_{GS} \leq 0, T_J = 125^\circ\text{C}$)

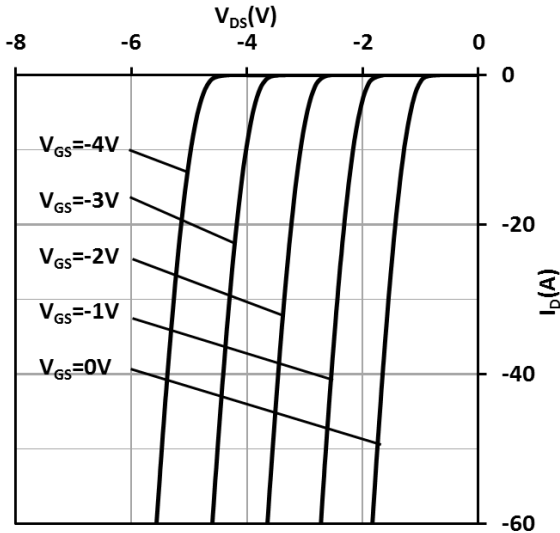


Fig. 10 Typ. Reverse Drain-Source Characteristics ($V_{GS} \geq 0, T_J = 125^\circ\text{C}$)

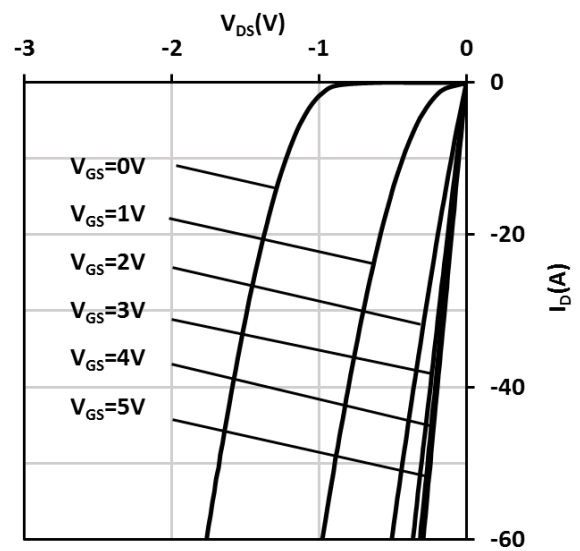


Fig. 11 Typ. Capacitances Characteristics

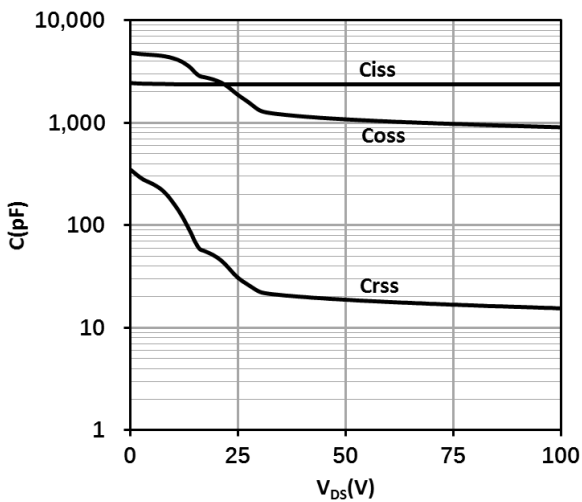


Fig. 12 Typ. Gate Charge

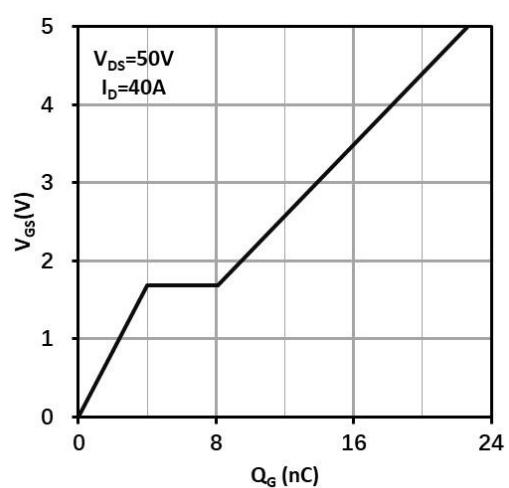


Fig. 13 Normalized Threshold Voltage vs. Temp.

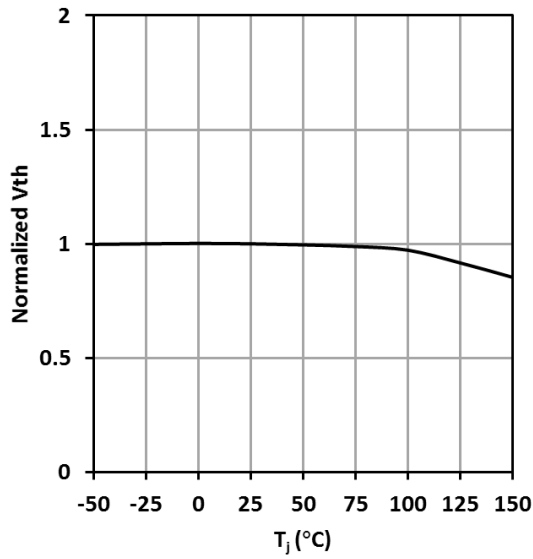


Fig. 14 Output Charge

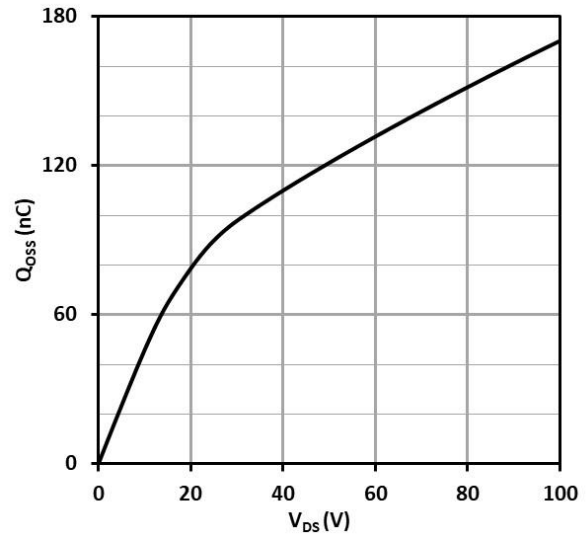


Fig. 15 Output Capacitance Stored Energy

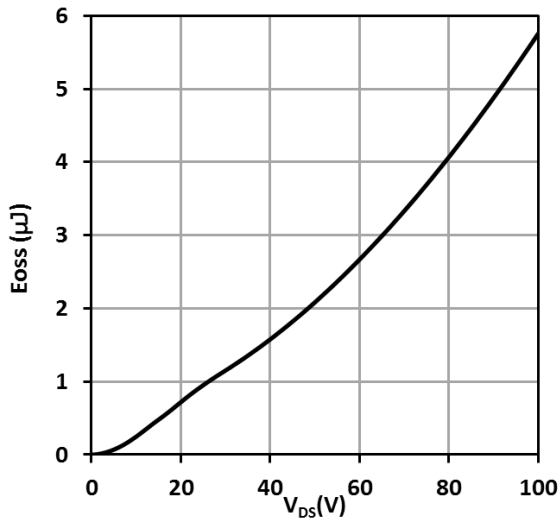


Fig. 16 Power Dissipation

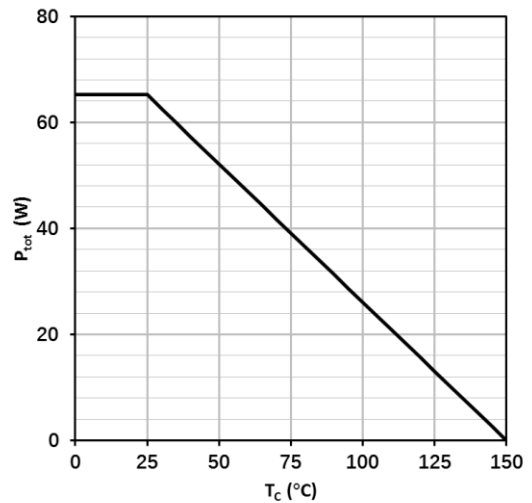


Fig. 17 Safe Operating Area

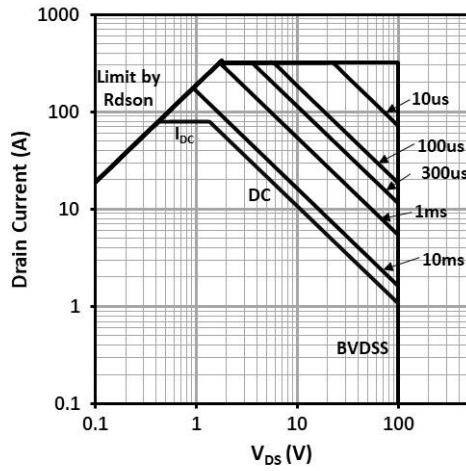
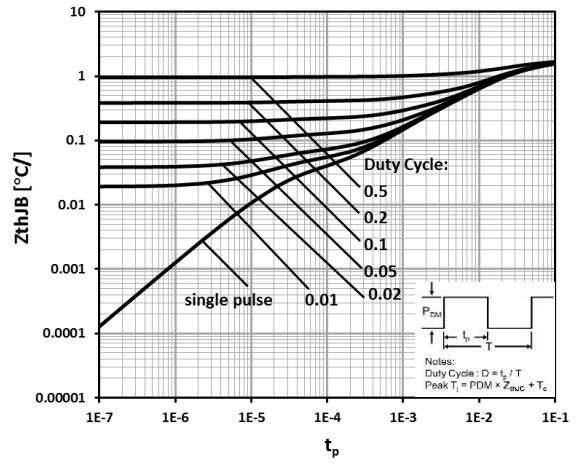
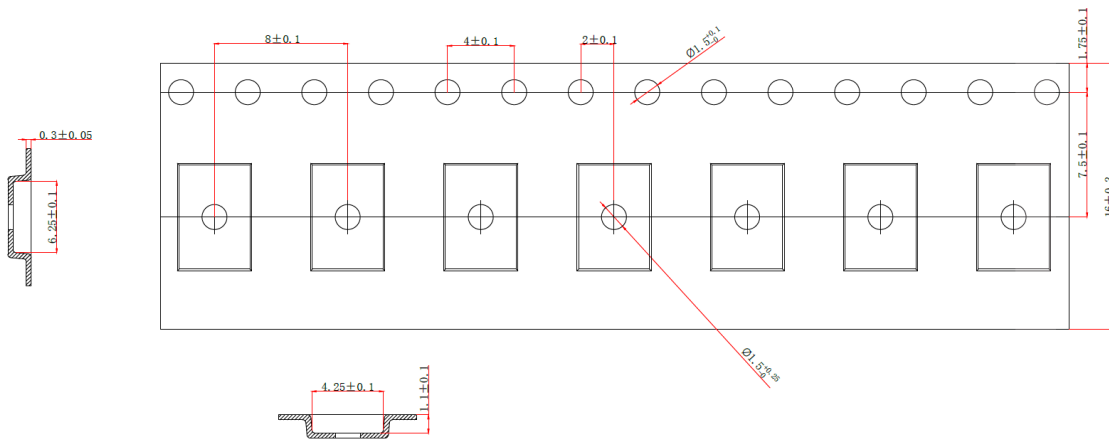


Fig. 18 Max. Transient Thermal Impedance

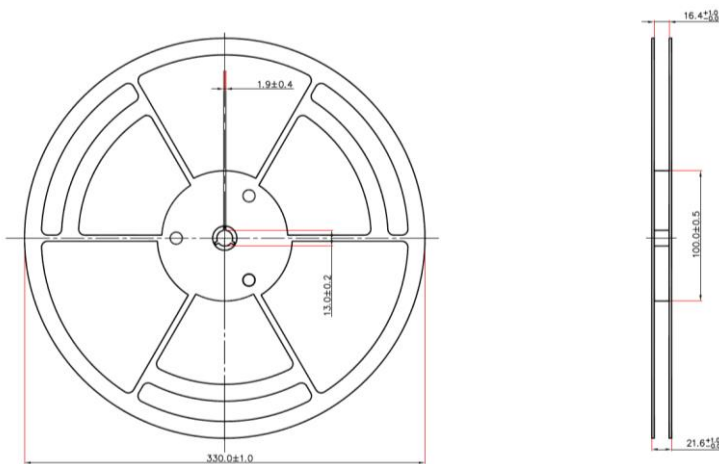


11. Reel information



NOTES:

1. CARRIER TAPE COLOR: BLACK.
2. COVER TAPE WIDTH: 13.3±0.10.
3. COVER TAPE COLOR: TRANSPARENT.
4. 10 SPROCKET HOLE PITCH CUMULATIVE TOLERANCE ±0.20 MAX.
5. CAMBER NOT TO EXCEED 1MM IN 100MM.
6. MOLD# QFN/DFN/MIS6X4X0.75/0.85.
7. ALL DIMS IN MM.
8. BAN TO USE THE ENVIRONMENT-RELATED SUBSANCES OF JCET PRESCRIBING.

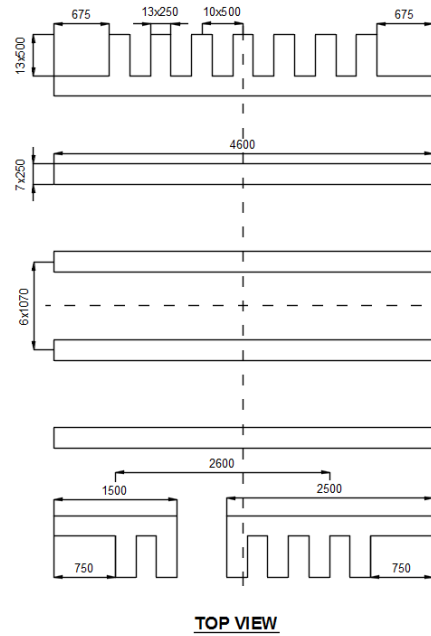


NOTES:

1. 2500 UNITS PER TRAY.
2. COLOR: WHITE.
3. ALL DIM IN mm.
4. GENERAL TOLERANCE±0.25.
5. BAN TO USE THE ENVIRONMENT-RELATED SUBSANCES OF JCET PRESCRIBING.
6. THE DERECTION OF VIEW:

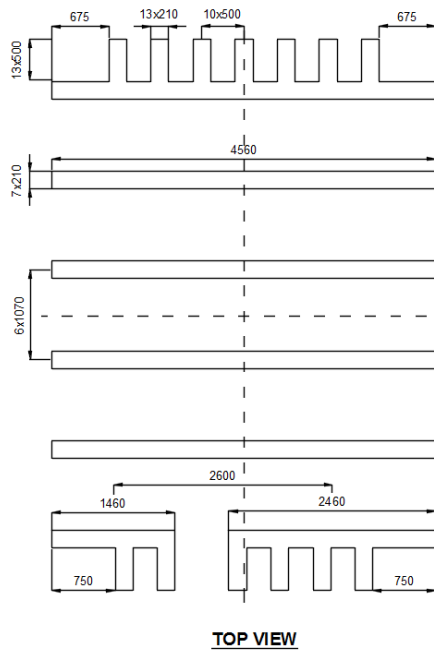
12. Land pattern

Recommended land pattern



Unit: μm

Recommended Stencil drawing



Unit: μm

13. Revision history

Major changes since the last revision

Revision	Date	Description of changes
1.0	2023-07-19	Version 1.0 release

Important Notice

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